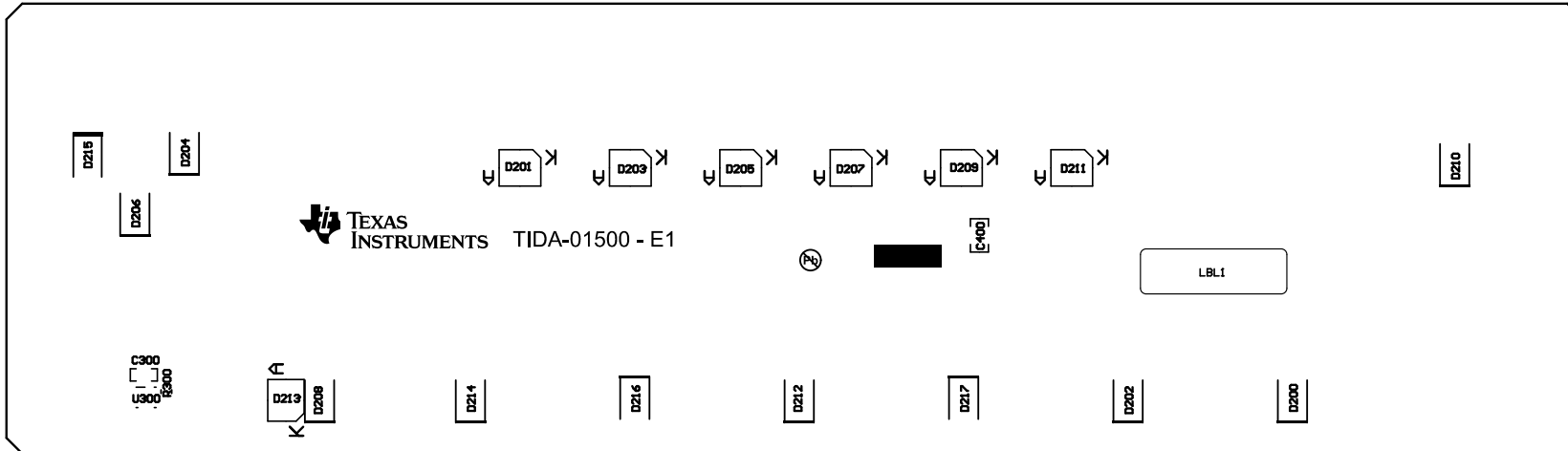
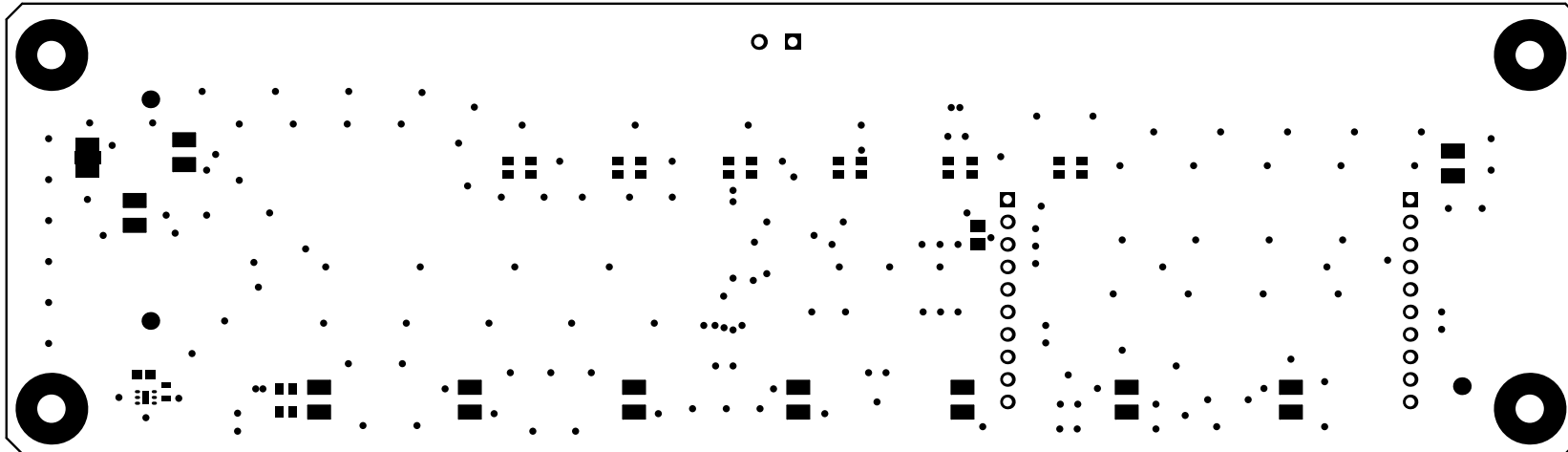


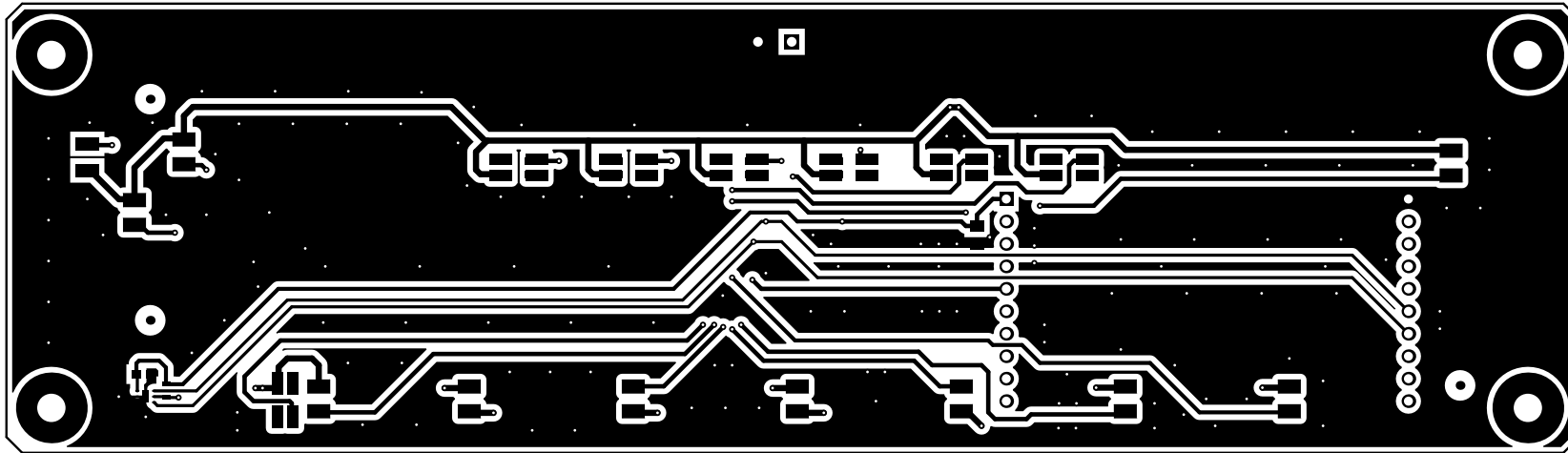
For evaluation only; not FCC approved for resale.



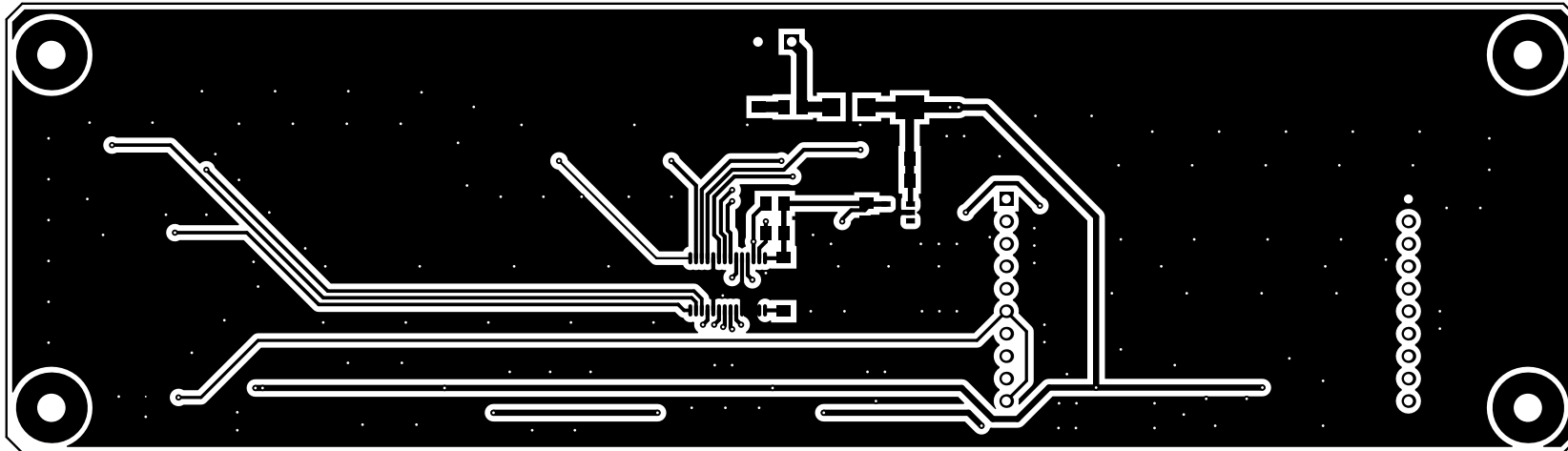
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: N/A		
PLOT NAME = Top Overlay	GENERATED : 10/25/2017 1:36:10 PM	TEXAS INSTRUMENTS	



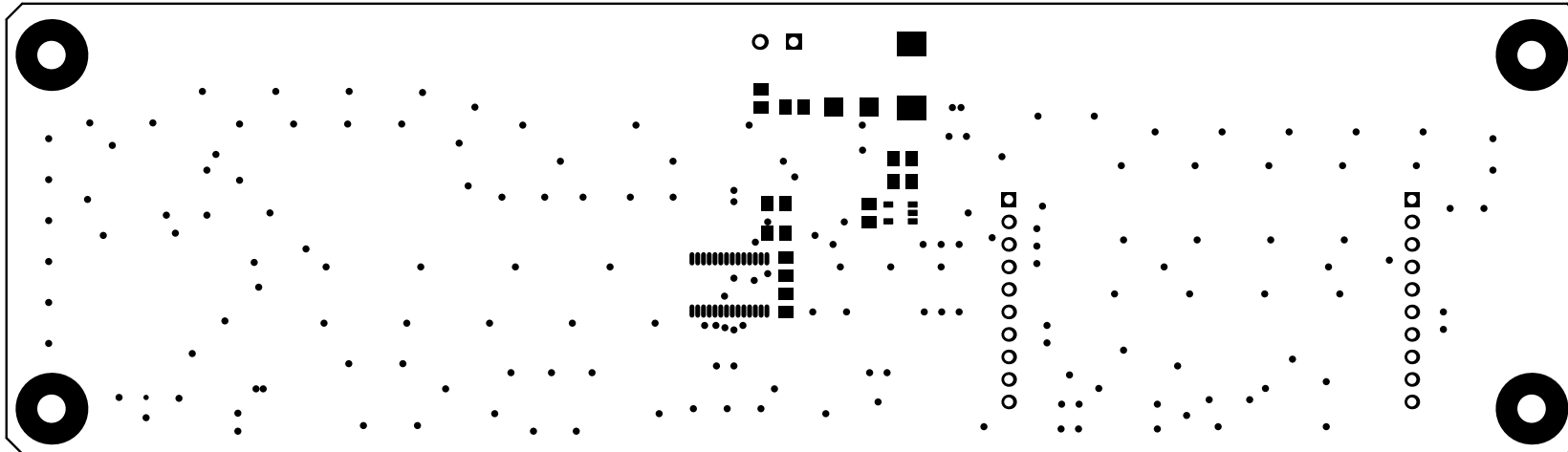
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01500	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 10/25/2017 1:36:10 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01500	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: N/A		
PLOT NAME = Top Layer	GENERATED : 10/25/2017 1:36:10 PM		TEXAS INSTRUMENTS

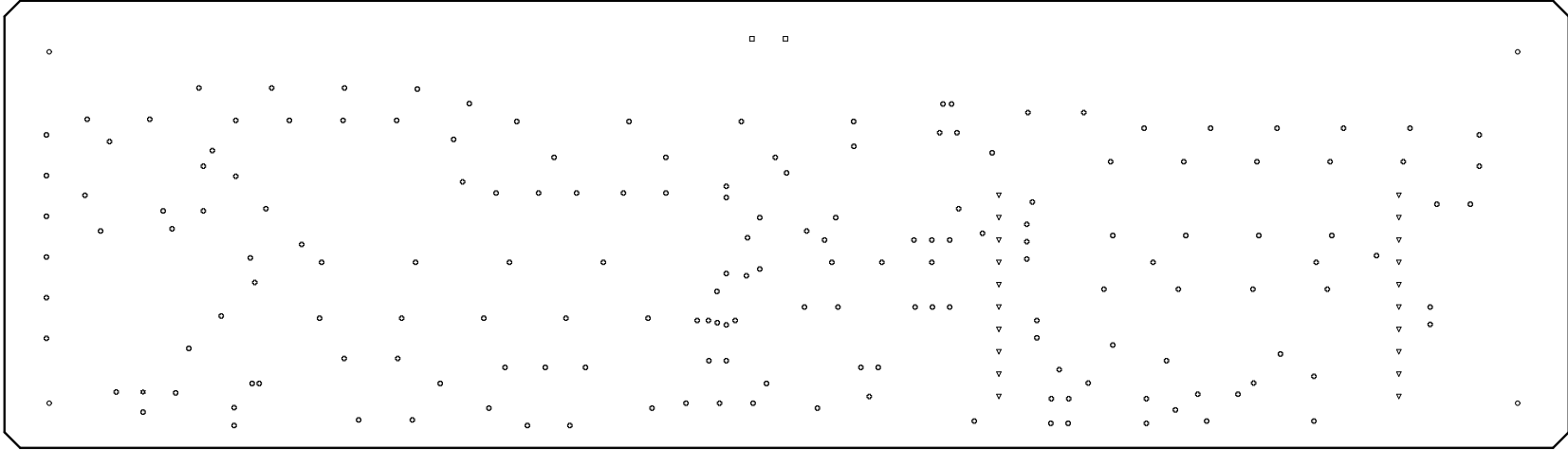


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01500	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 10/25/2017 1:36:10 PM	TEXAS INSTRUMENTS	

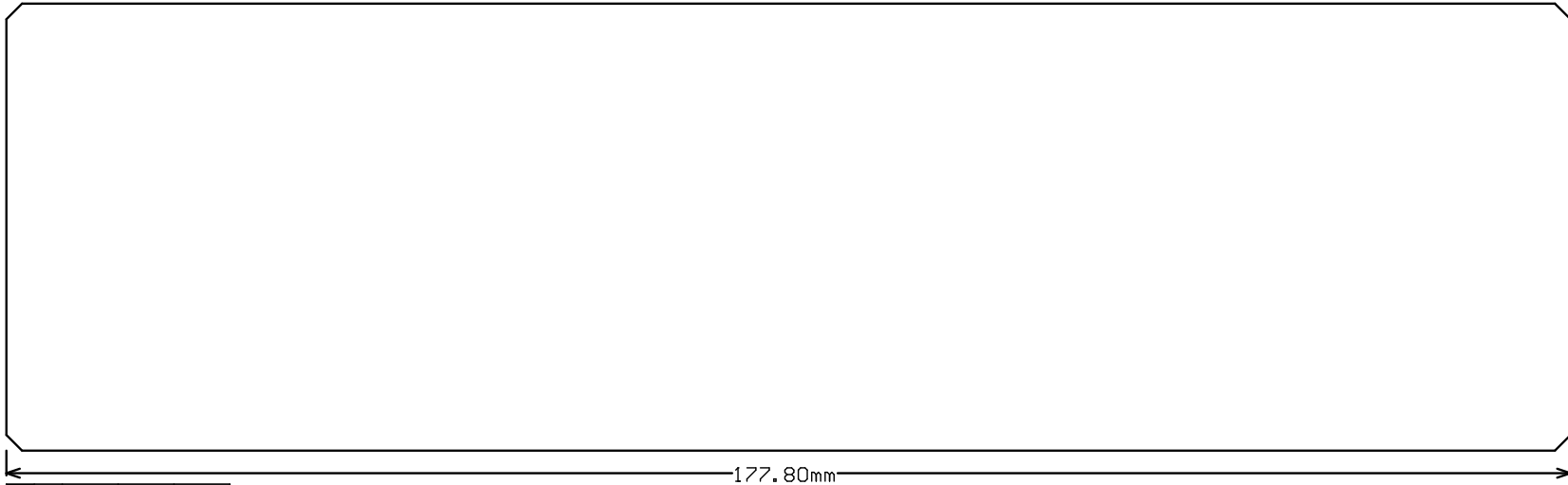


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01500	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 10/25/2017 1:36:11 PM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
⚙	1	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	174	11.81mil (0.300mm)	PTH	Round	Top Layer - Bottom Layer	
▽	20	40.16mil (1.020mm)	PTH	Round	Top Layer - Bottom Layer	
□	2	43.31mil (1.100mm)	PTH	Round	Top Layer - Bottom Layer	
○	4	125.98mil (3.200mm)	PTH	Round	Top Layer - Bottom Layer	
	201 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 10/25/2017 1:36:11 PM	TEXAS INSTRUMENTS	



177.80mm

25.40mm

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01500	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 10/25/2017 1:36:12 PM	TEXAS INSTRUMENTS	

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